

### **Product Change Notification / GBNG-05QEVI441**

### Date:

21-Sep-2023

### **Product Category:**

Clock and Timing - Clock and Data Distribution

# **PCN Type:**

Manufacturing Change

# **Notification Subject:**

CCB 6250 Final Notice: Qualification of NSEB as a new assembly site for SY100EPxxx and SY89645L device families available in 20L TSSOP (4.4mm) package.

### **Affected CPNs:**

GBNG-05QEVI441\_Affected\_CPN\_09212023.pdf GBNG-05QEVI441\_Affected\_CPN\_09212023.csv

### **Notification Text:**

**PCN Status:**Final Notification

**PCN Type:**Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of NSEB as a new assembly site for SY100EPxxx and SY89645L device families available in 20L TSSOP (4.4mm) package.

#### Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	Amkor Technology Philippine (P1/P2), INC.	UTAC Thai Limited (UTL-1) LTD./

	(ANAP)	NSEB					
Wire material	Au	Au					
Die attach material	8290	8200T					
Molding compound material	G700K	G605-L					
Lead frame material	C7025	C7025					
Lead plating	NiPdAu	Matte Tin					
Lead frame paddle size	118x165 mil	95x142 mil					
DAP Surface Prep	PPF	Ag-Ring					
Lead-lock	Dimple	Lead design locking					
Lead frame design	See Pre and Post C	Post Change comparison					

### Impacts to Data Sheet:None

## Change ImpactNone

**Reason for Change:**To improve on-time delivery performance by qualifying NSEB as a new assembly site.

### **Change Implementation Status:**In Progress

Estimated First Ship Date: November 3, 2023 (date code: 2344)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

### Time Table Summary:

	May 2023			>	Se	September 2023				>	November 2023						
Workweek	1 8	1 9	2	2 1	2 2		3 5	3 6	3 7	3 8	3 9		4	4 5	4 6	4 7	4 8
Initial PCN Issue Date		Х															
Qual Report Availability										Х							
Final PCN Issue Date										Х							
Estimated Implementation Date													Х				

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:**May 10, 2023: Issued initial notification.

September 21, 2023: Issued final notification. Attached the Qualification Report. Provided estimated first ship date to be on November 3, 2023.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

#### Attachments:

PCN\_GBNG-05QEVI441\_Pre\_and\_Post\_Change\_Summary.pdf PCN\_GBNG-05QEVI441\_Qualification Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

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If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

SY100EP56VK4G

SY100EP57VK4G

SY89645LK4G

SY100EP56VK4G-TR

SY100EP57VK4G-TR

SY89645LK4G-TR

Date: Thursday, September 21, 2023